





# SMART-SIZED HIGH SPEED DISPENSER

Introducing - The Spider - PCB design freedom. State-of-the-art technology, easily integrated in any line.



## dispense technology.

- Up to 2 valves simultaneously
- 5 different valves, large application range

### productivity.

- Valve up to 720'000 System Ø 180'000 dots/h
- Up to 2'000'000 dot/h line mode

### small footprint

- Requires only 1 m² of production floor
- Machine fits through 90 cm wide door

#### mineral cast.

- No vibration, symmetrical mineral casting
- No warpage, no thermal drift

# laser height mapping

- Mapping of heights using laser technology
- Compensation of substrate warp / 3D contour

### linear motors

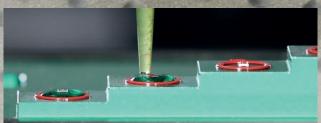
- Fast, reliable double drive linear motors
- No maintenance, longest lifetime

naturally adaptive.

# INTEGRATE INTO HIGH SPEED LINES AND HIGHLY COMPLEX DISPENSE APPLICATIONS



Versatile range of dispensing applications such as Solder Paste and SMT Glue, LED Encapsulation, Silver Epoxy, Dam and Fill, Underfill, Cavity Fill, 2.5D Dispensing via laser height mapping & more



Full operator support - Automated error analysis & KPI. Training, support and troubleshooting via advanced remote access. Investment protection; all options and heads retrofittable.



Two processes at the same time. Plug and Play for valve change. Piezo Jet Valve - super high speed for low viscosity. Dynamic Shockwave, Volume Displacement, Time/Pressure, Archimedean Screw Valve





**MULTITALENT SOFTWARE AT YOUR FINGERTIPS** State of the art, full graphics, 21.5" 16:9 touch screen, Windows - 64 bit, fingertip operation, real time visualization zoom at camera windows, all-in-one job planning, universal CAD conversion, setup optimization, easy definition of pattern and guided process support

### optional.

Valves & Pumps

Media Heating

Level Detection

Needle and jet heating system

Automatic syringe level detection

Process Control Process control adjustment & stabilization

Integrated Inspection 2D defect detection for dispensed material

Vacuum Cleaning Station, High Precision Scale, Clean Room, Heating/Vacuum Table Full process control meeting automotive standards and more







# naturally adaptive.

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Process	Max. dispensing speed	Piezo Jet: > 720'000 dots/h Solder Paste Jet: 720'000 dots/h	Time/Pressure: 28'000 dots/h Archimedean Screw: 24'000 dots/h
	Dispensing mode	Dot, line, curve, interpolated 3D contour	
Accuracy	Placement XY dots	40 μm (3σ)	
	Positioning Z axis	20 μm (3σ)	
PCB	PCB dimensions	50 x 50 mm up to 406 x 305 mm	(2 x 2" up to 16 x 12")
Dimensions	Machine footprint	880 x 1090 mm (34.7 x 43")	



Wildlife consistently shows us with breathtaking flexibility how nature can adapt itself to the many different demands of its environment; that is what inspires us! Essemtec AG is a company with its development and production site in Switzerland. The product portfolio comprises of production equipment for electronic assembly and more. Our high-tech solutions can be adjusted quickly and easily to meet wide ranging requirements; we are therefore able to respond to all manner of customer requests. That's why "naturally adaptive" is our motto across all ranges.

#### Disclaimer & Copyright:

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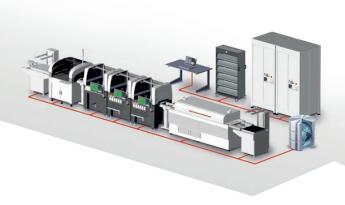
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